

GENERAL DESCRIPTION

The SGM42203 is a high-side driver intended for a wide range of industrial applications. It is usually used to drive resistive or inductive load with the other terminal connected to GND. The device integrates load current sense function through the current sense pin current out. If overload current, over-temperature or short-to-VCC occurs, the current sense pin will function to report these faults.

The current limit protects the device in case of overload conditions. Built-in output current limit mask-time allows the current limit to foldback to a preset (selectable) lower level after a preset (adjustable) time delay to protect the load more robustly per application demands.

The fault status will be reset by pulling low the fault reset standby pin (nFR_STBY). Pulling all the inputs and nFR_STBY pins low will disable the device and leave it in standby state.

The SGM42203 is available in a Green TSSOP-16A (Exposed Pad) package.

APPLICATIONS

- Resistive Loads
- Inductive Loads
- Capacitive Loads

FEATURES

- **Wide Supply Voltage Range: 5V to 36V**
- **Low $R_{DS(ON)}$: 80m Ω /Channel (TYP)**
- **Low Off-State Supply Current: 3.5 μ A (TYP)**
- **Current Sense Gain: 1700**
- **Built-in Variable Over-Current Mask-Time Setting Function**
- **Programmable Over-Current Limit: 2.5A, 5A, 10A, 15A**
- **3V and 5V Compatible Logic Inputs**
- **High Accurate Proportional Load Current Sense for Both Channels**
- **Continues Load Current:**
 - ◆ 3.5A, 1-Channel On
 - ◆ 2.5A/CH, 2-Channel On
- **Open-Load Detection in Off-State**
- **Short-to-GND Protection by Current Limit**
- **Thermal Shutdown with Latch or Restart Option**
- **Inductive Load Negative Voltage Clamp**
- **Loss-of-GND and Loss-of-Battery Protection**
- **Under-Voltage Shutdown**

TYPICAL APPLICATION

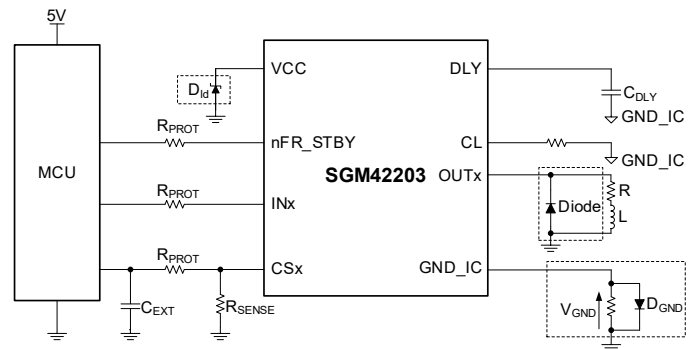
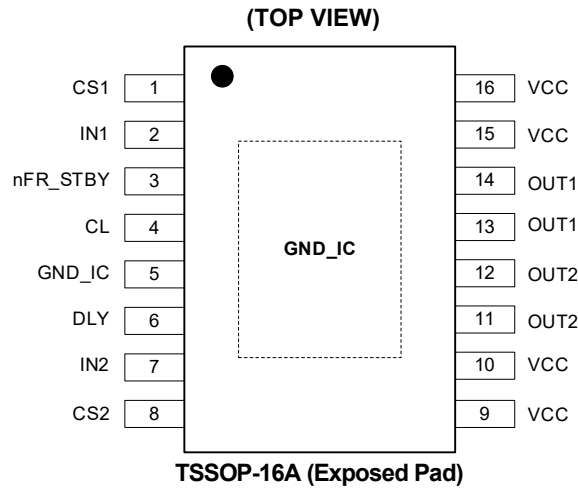


Figure 1. Application Schematic

For high voltage applications ($\geq 32V$), the following application measures are recommended:

1. To ensure robustness against short-circuit/inductive load energy dissipation during hot-plug, a suitable clamping Diode or TVS must be connected externally to the OUTx pin.
2. The current limit is set to 2.5A or 5A through the CL pin.
3. The DLY pin is connected to a 100pF capacitor or left floating.

PIN CONFIGURATION



PIN DESCRIPTION

PIN	NAME	FUNCTION
1	CS1	Current Sense Output Pin. The out-going current is proportional to the load current. Connect it to the ground through a 10kΩ resistor if not used. It is not allowed to be floating.
8	CS2	
2	IN1	Voltage Controlled Input Pin. Control the output switch state. Connect it to the ground through a 10kΩ resistor if not used.
7	IN2	
3	nFR_STBY	Active-Low Reset Output/Standby Mode Pin. When over-temperature or over-current occurs and latches, pull nFR_STBY pin down to reset the device. If all the inputs and nFR_STBY pins are low, the device will enter into standby state. Connect it to the ground through a 10kΩ resistor if not used.
4	CL	Adjustable Current Limit. Connect respective resistor to GND_IC to set the current limit foldback level. If the current limit foldback function is not used, short this pin and the DLY pin to GND_IC.
5	GND_IC	
6	DLY	Over-Current Mask-Time Setting Pin. Connect respective capacitor to set the over-current mask-time. If the current limit foldback function is not used, short this pin and the CL pin to GND_IC.
9, 10, 15, 16	VCC	Power Supply. Short all the VCC pins together and connect to the supply. Do not let any of VCC pin floating.
13, 14	OUT1	Power Output. Do not connect to ground if the channel is not used, should leave it floating, there is an internal high-valued resistor as bleeding path.
11, 12	OUT2	
Exposed Pad	GND_IC	Device Ground.

FUNCTIONAL BLOCK DIAGRAM

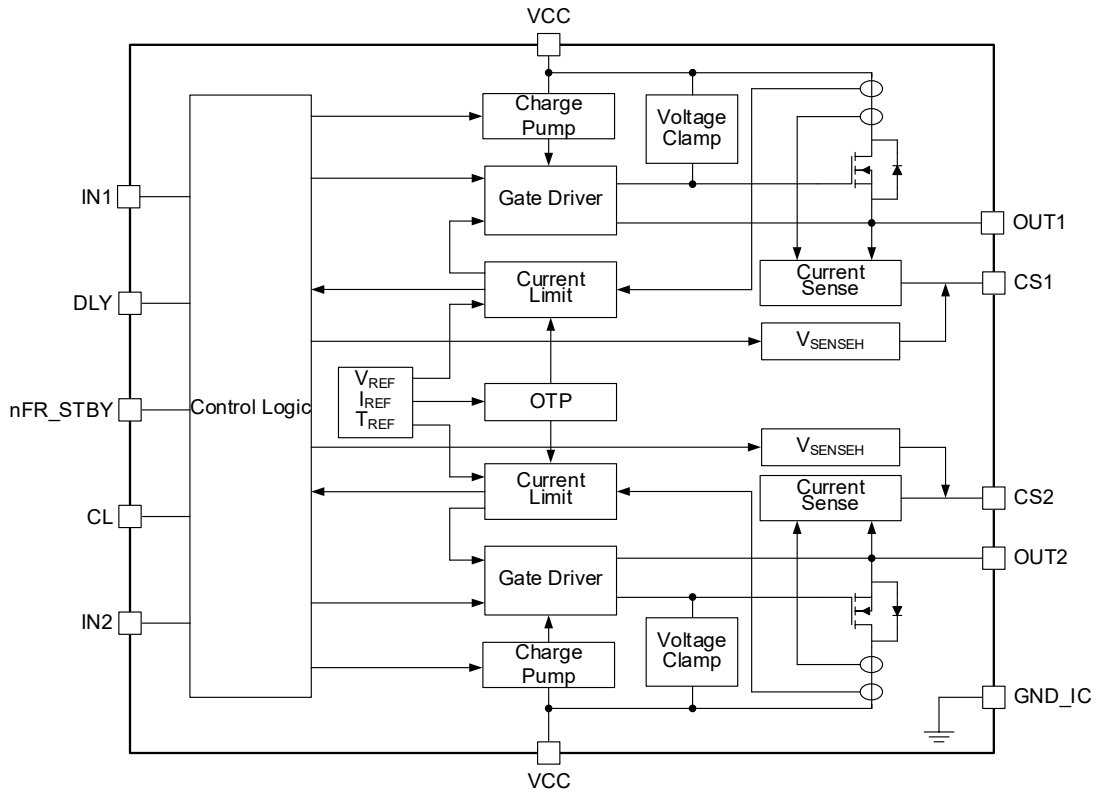
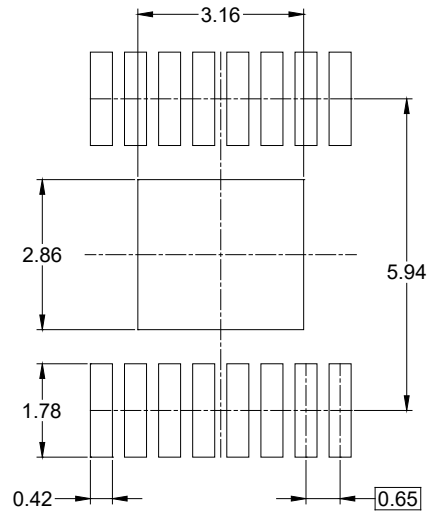
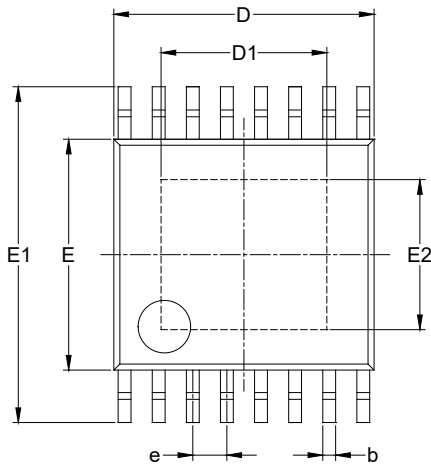


Figure 2. Block Diagram

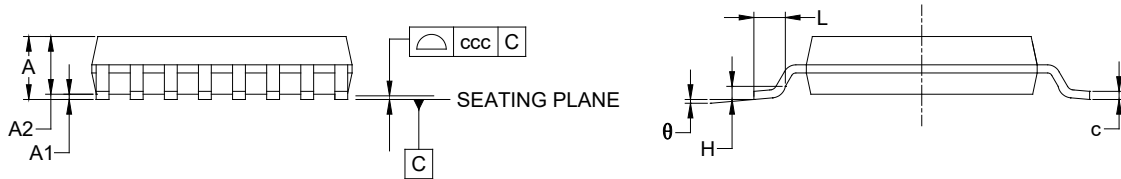
PACKAGE INFORMATION

PACKAGE OUTLINE DIMENSIONS

TSSOP-16A (Exposed Pad)



RECOMMENDED LAND PATTERN (Unit: mm)



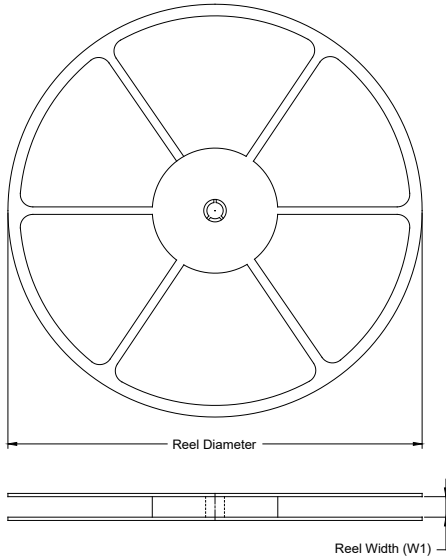
Symbol	Dimensions In Millimeters		
	MIN	NOM	MAX
A	-	-	1.200
A1	0.000	-	0.150
A2	0.800	-	1.050
b	0.190	-	0.300
c	0.090	-	0.200
D	4.860	-	5.100
D1	2.960	-	3.360
E	4.300	-	4.500
E1	6.200	-	6.600
E2	2.660	-	3.060
e	0.650 BSC		
L	0.450	-	0.750
H	0.250 TYP		
θ	0°	-	8°
ccc	0.100		

NOTES:

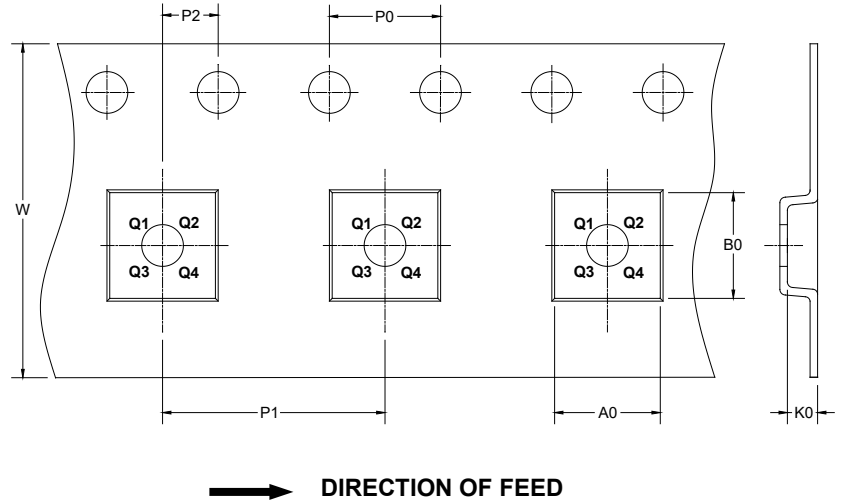
1. This drawing is subject to change without notice.
2. The dimensions do not include mold flashes, protrusions or gate burrs.
3. Reference JEDEC MO-153.

TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

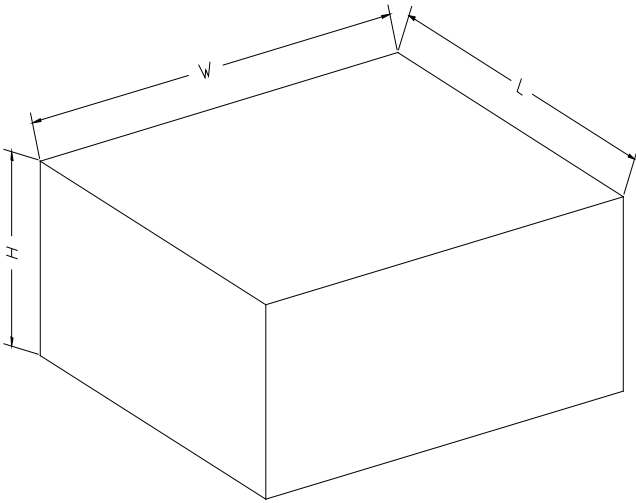
KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
TSSOP-16A (Exposed Pad)	13"	12.4	6.80	5.40	1.50	4.0	8.0	2.0	12.0	Q1

DD0001

PACKAGE INFORMATION

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
13"	386	280	370	5

DD0002